

## L29C520/521

# 4 x 8-bit Multilevel Pipeline Register

#### **FEATURES**

- ☐ Four 8-bit Registers
- ☐ Implements Double 2-Stage Pipeline or Single 4-Stage Pipeline Register
- ☐ Hold, Shift, and Load Instructions
- ☐ Separate Data In and Data Out Pins
- ☐ High-Speed, Low Power CMOS Technology
- ☐ Three-State Outputs
- ☐ DECC SMD No. 5962-91762
- ☐ Available 100% Screened to MIL-STD-883, Class B
- ☐ Replaces IDT29FCT520/IDT29FCT521 and AMD Am29520/Am29521
- ☐ Package Styles Available:
  - 24-pin Plastic DIP
  - 24-pin Ceramic DIP
  - 28-pin Plastic LCC, J-Lead
  - 28-pin Ceramic LCC
  - 24-pin Ceramic Flatpack
  - 24-pin Plastic SSOP

#### DESCRIPTION

The L29C520 and L29C521 are pinfor-pin compatible with the IDT29FCT520/IDT29FCT521 and AMD Am29520/Am29521, implemented in low power CMOS.

The L29C520 and L29C521 contain four registers which can be configured as two independent, 2-level pipelines or as one 4-level pipeline.

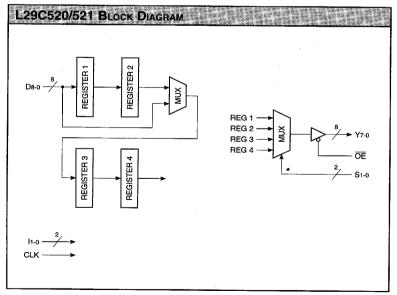
The Instruction pins, I1-0, control the loading of the registers. For either device, the registers may be configured as a four-stage delay line, with data loaded into R1 and shifted sequentially through R2, R3, and R4. Also, for the L29C520, data may be loaded from the inputs into either R1 or R3 with only R2.or R4 shifting. The L29C521 differs from the L29C520 in that R2 and R4 remain unchanged during this type of data load, as shown in Tables 1 and 2. Finally, I1-0 may be set to prevent any register from changing.

The S1-0 select lines control a 4-to-1 multiplexer which routes the contents of any of the registers to the Y output pins. The independence of the I and S controls allows simultaneous write and read operations on different registers.

#### TABLE 1. L29C520 INSTRUCTION TABLE lı Description L L D→R1 R1→R2 R2→R3 R3→R4 L Н HOLD HOLD D→R3 R3→R4 D→R1 R1→R2 HOLD HOLD н ALL REGISTERS ON HOLD

医测压器	TABLE 2. L29C521 Instruction Table								
ĺΊ	lo	Descrip	otion						
L	L	D→R1	R1→R2	R2→R3	R3→R4				
L	н	HOLD	HOLD	D→R3	HOLD				
н	L	D→R1	HOLD	HOLD	HOLD				
Н	Н	ALL RE	GISTERS	ON HOLE	)				

TABLE 3. OUTPUT SELECT							
<b>\$</b> 1	So	Register Selected					
L	L	Register 4					
L	н	Register 3					
Н	L	Register 2					
Н	Н	Register 1					



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## 4 x 8-bit Multilevel Pipeline Register

Storage temperature	65°C to +150°C
Operating ambient temperature	55°C to +125°C
Vcc supply voltage with respect to ground	0.5 V to +7.0 \
Input signal with respect to ground	
Signal applied to high impedance output	
Output current into low outputs	
Latchup current	

	OPERATING CONDITIONS To meet spec	ified electrical and switching character	istics
	Mode	Temperature Range (Ambient)	Supply Voltage
1	Active Operation, Commercial	0°C to +70°C	4.75 V ≤ <b>V</b> CC ≤ 5.25 V
	Active Operation, Military	-55°C to +125°C	4.50 V ≤ <b>V</b> CC ≤ 5.50 V

ELECTRIC	CAL CHARACTERISTICS. Ove	er Operating Conditions (Note 4)		(* julius in j Tali		
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
<b>V</b> 0H	Output High Voltage	Vcc = Min., IoH = -15.0 mA	2.4			٧
<b>V</b> OL	Output Low Voltage	Vcc = Min., IoL = 24.0 mA			0.5	٧
<b>V</b> iн	Input High Voltage		2.0		Vcc	V
<b>V</b> iL	Input Low Voltage	(Note 3)	0.0		0.8	٧
lix	Input Current	Ground ≤ VIN ≤ VCC (Note 12)			±20	μΑ
loz	Output Leakage Current	Ground ≤ VOUT ≤ VCC (Note 12)			±20	μA
ICC1	Vcc Current, Dynamic	(Notes 5, 6)			30	mA
ICC2	Vcc Current, Quiescent	(Note 7)			1.5	mA

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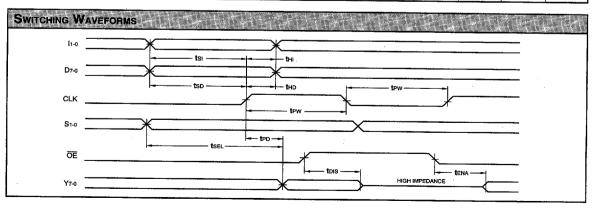


### 4 x 8-bit Multilevel Pipeline Register

#### SWITCHING CHARACTERISTICS

Сомме	RCIAL OPERATING RANGE (0°C to +70°C) Notes 9, 10 (ns)			14年2月 14年2月2			
			L29C520/521-				
			22		14		
Symbol	Parameter	Min	Max	Min	Max		
tPD	Clock to Output Delay		22		14		
tsel	Select to Output Delay		20	· ·	13		
tpw	Clock Pulse Width	10		7			
tsı	Instruction Setup Time	10		5			
tHI	Instruction Hold Time	3		1			
tsd	Data Setup Time	10		5			
<b>t</b> HD	Data Hold Time	3		1			
<b>t</b> ENA	Three-State Output Enable Delay (Note 11)		21		15		
tois	Three-State Output Disable Delay (Note 11)		15		12		

MILITAR	Y OPERATING RANGE (-55°C to +125°C) Note	s 9, 10 (ns)						
		L29C520/521-						
		3	30		24		16	
Symbol	Parameter	Min	Max	Min	Max	Min	Max	
<b>t</b> PD	Clock to Output Delay	•	30		24		16	
tsel	Select to Output Delay		30		22		15	
<b>t</b> PW	Clock Pulse Width	15		10		8	-	
tsı	Instruction Setup Time	15		10		6		
tHI	Instruction Hold Time	5		3		2		
tsD	Data Setup Time	15		10		6		
tHD	Data Hold Time	5		3		2		
tENA	Three-State Output Enable Delay (Note 11)		25		22		16	
tois	Three-State Output Disable Delay (Note 11)		20		16	·	13	



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#### 4 x 8-bit Multilevel Pipeline Register

#### NOTES

- 1. Maximum Ratings indicate stress specifications only. Functional operation of these products at values beyond those indicated in the Operating Conditions table is not implied. Exposure to maximum rating conditions for extended periods may affect reliability.
- 2. The products described by this specification include internal circuitry designed to protect the chip from damaging substrate injection currents and accumulations of static charge. Nevertheless, conventional precautions should be observed during storage, handling, and use of these circuits in order to avoid exposure to excessive electrical stress values.
- 3. This device provides hard clamping of transient undershoot and overshoot. Input levels below ground or above VCC will be clamped beginning at -0.6 V and VCC +0.6 V. The device can withstand indefinite operation with inputs in the range of -0.5 V to +7.0 V. Device operation will not be adversely affected, however, input current levels will be well in excess of 100 mA.
- 4. Actual test conditions may vary from those designated but operation is guaranteed as specified.
- 5. Supply current for a given application can be accurately approximated by:

VCV<sup>2</sup>F

where

N = total number of device outputs

C = capacitive load per output

V = supply voltage F = clock frequency

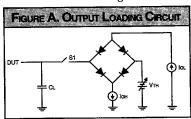
- 6. Tested with all outputs changing every cycle and no load, at a 5 MHz clock rate.
- 7. Tested with all inputs within  $0.1\ V$  of VCC or Ground, no load.
- 8. These parameters are guaranteed but not 100% tested.

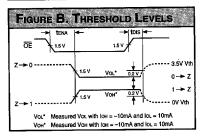
9. AC specifications are tested with input transition times less than 3 ns, output reference levels of 1.5 V (except tDIS test), and input levels of nominally 0 to 3.0 V. Output loading may be a resistive divider which provides for specified IOH and IOL at an output voltage of VOH min and VOL max respectively. Alternatively, a diode bridge with upper and lower current sources of IOH and IOL respectively, and a balancing voltage of 1.5 V may be used. Parasitic capacitance is 30 pF minimum, and may be distributed.

This device has high-speed outputs capable of large instantaneous current pulses and fast turn-on/turn-off times. As a result, care must be exercised in the testing of this device. The following measures are recommended:

- a. A 0.1 µF ceramic capacitor should be installed between VCC and Ground leads as close to the Device Under Test (DUT) as possible. Similar capacitors should be installed between device VCC and the tester common, and device ground and tester common.
- b. Ground and VCC supply planes must be brought directly to the DUT socket or contactor fingers.
- c. Input voltages should be adjusted to compensate for inductive ground and VCC noise to maintain required DUT input levels relative to the DUT ground pin.
- 10. Each parameter is shown as a minimum or maximum value. Input requirements are specified from the point of view of the external system driving the chip. Setup time, for example, is specified as a minimum since the external system must supply at least that much time to meet the worst-case requirements of all parts. Responses from the internal circuitry are specified from the point of view of the device. Output delay, for example, is specified as a maximum since worst-case operation of any device always provides data within that time.

- 11. For the tena test, the transition is measured to the 1.5 V crossing point with datasheet loads. For the tDIS test, the transition is measured to the ±200mV level from the measured steady-state output voltage with ±10mA loads. The balancing voltage, VTH, is set at 3.5 V for Z-to-0 and 0-to-Z tests, and set at 0 V for Z-to-1 and 1-to-Z tests.
- 12. These parameters are only tested at the high temperature extreme, which is the worst case for leakage current.

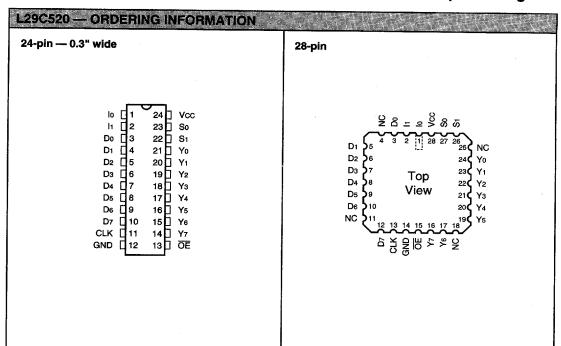




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## 4 x 8-bit Multilevel Pipeline Register



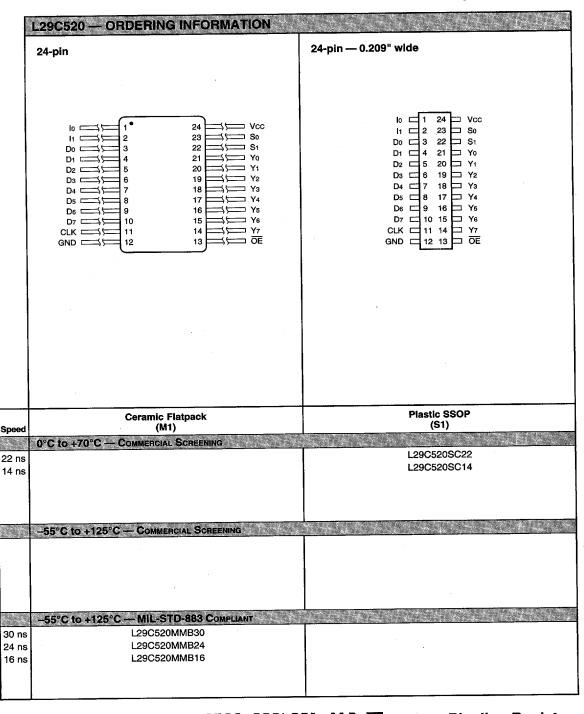
Plastic DIP (P2) +70°C — COMMERCIAL	Ceramic DIP (C1)	Plastic J-Lead Chip Carrier (J4)	Ceramic Leadless Chip Carrier (K1)
+70°C - COMMERCIAL	C		
	. OCHEENING		I Tarrit and the second
L29C520PC22 L29C520PC14	L29C520CC22 L29C520CC14	L29C520JC22 L29C520JC14	L29C520KC22 L29C520KC14
to +125°C — Commer			
	L29C520CM30 L29C520CM24 L29C520CM16		L29C520KM30 L29C520KM24 L29C520KM16
to +125°C — MIL-ST	D-883 COMPLIANT		
	L29C520CMB30 L29C520CMB24		L29C520KMB30 L29C520KMB24 L29C520KMB16
	29С520РС14 to +125°С — Соммен	29C520PC14  L29C520CC14  to +125°C — Commercial Screening  L29C520CM30  L29C520CM24  L29C520CM16  to +125°C — MIL-STD-883 Compliant  L29C520CMB30	29C520PC14  L29C520CC14  L29C520JC14  to +125°C — Commercial Screening  L29C520CM30

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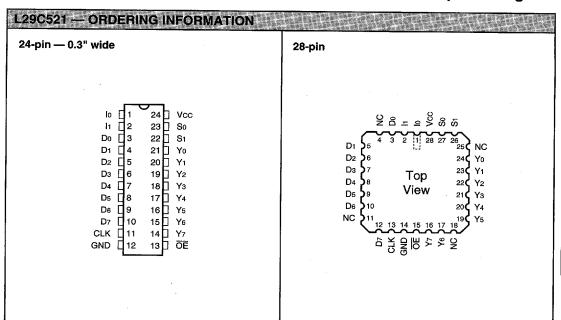
#### 4 x 8-bit Multilevel Pipeline Register



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### 4 x 8-bit Multilevel Pipeline Register



	Plastic DIP	Ceramic DIP	Blackle I Lead Ohio Comban	0		
Speed	(P2)	(C1)	Plastic J-Lead Chip Carrier (J4)	Ceramic Leadless Chip Carrier (K1)		
+17.	0°C to +70°C — Commercia	AL SCREENING		Carron Habar - Pint		
22 ns 14 ns	L29C521PC22 L29C521PC14	L29C521CC22 L29C521CC14	L29C521JC22 L29C521JC14	L29C521KC22 L29C521KC14		
30 ns	-55°C to +125°C — Comme	FICIAL SCREENING L29C521CM30		L29C521KM30		
24 ns 16 ns		L29C521CM24 L29C521CM16		L29C521KM24 L29C521KM16		
30 ns 24 ns 16 ns	-55°C to +125°C MIL-S	TD-883 COMPLIANT  L29C521CMB30  L29C521CMB24  L29C521CMB16		L29C521KMB30 L29C521KMB24 L29C521KMB16		

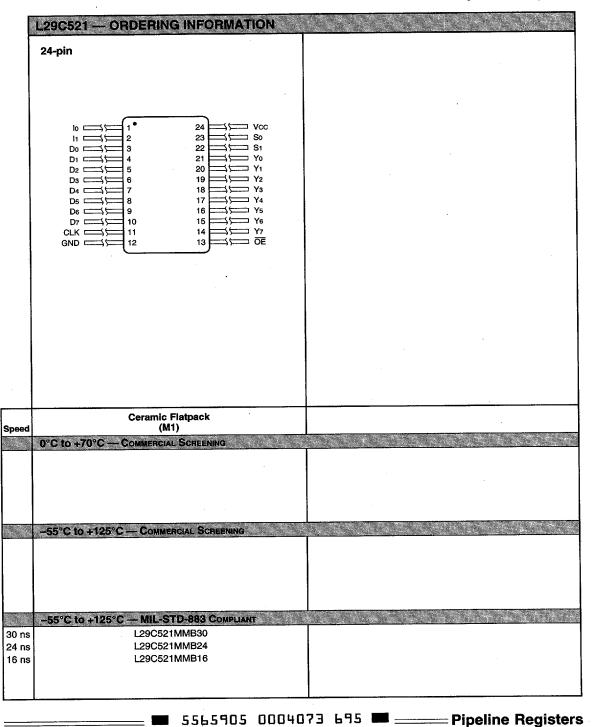
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#### 4 x 8-bit Multilevel Pipeline Register



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